

关键参数 Key Parameters

V_{DSmax}		1200	V
$R_{DS(on)}$	Typ.	25	mΩ
I_D	Max.	82	A

典型应用 Typical Application

- OBC On Board Charger
- DC-DC DC-DC Converter
- 充电桩 Battery Chargers
- 光伏逆变 Solar Inverters

特点 Features

- 高开关频率 High Switching Frequency
- 低开关损耗 Low Switching Loss
- 软、快速开关 Soft, fast Switching
- 易并联使用 Easy Paralleling

电路结构 Circuit Configuration

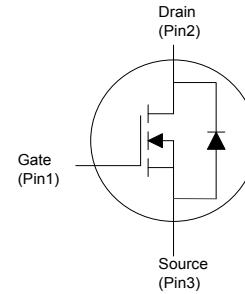


图 1. 电路结构

Fig. 1 Circuit configuration

器件外形 Device Appearance

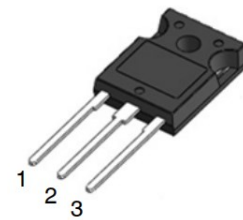


图 2. 模块外形

Fig. 2 Device appearance

最大额定值

Maximum Ratings

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions	数值 Value	单位 Unit
V_{DSS}	漏源极电压 Drain-source voltage	$V_{GS}=0V, T_C \geq 25^\circ C$	1200	V
V_{GSS}	栅源电压 Gate-source voltage	$T_C=25^\circ C$	-8/+23	V
V_{GSop}	栅源电压 Gate-source voltage		-4/+18	V
I_D	持续正向电流, 由 $T_{vj\ max}$ 限制 Continuous forward current, limited by $T_{vj\ max}$	$T_C=25^\circ C, T_{vj\ max}=175^\circ C$	82	A
		$T_C=100^\circ C, T_{vj\ max}=175^\circ C$	63	A
I_{DM}	最大重复正向电流, 由 $T_{vj\ max}$ 限制 Maximum repetitive forward current, limited by $T_{vj\ max}$	$t_P=1ms$	164	A
$T_{vj\ max}$	最大允许结温 Max. Junction temperature		175	$^\circ C$
$T_{vj(op)}$	工作结温 Operation junction temperature		-55...+175	$^\circ C$

T_{stg}	存储温度 Storage temperature range		-55...+150	°C
M	安装力矩 - M3 Mounting Torque - M3		0.6	Nm

电特性值
Electrical Characteristics

 除非特别声明，否则 $T_{\text{vj}} = 25\text{ °C}$
 $T_{\text{vj}} = 25\text{ °C}$ unless otherwise stated

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
I_{DSS}	零栅压漏极电流 Zero gate voltage drain current	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = V_{\text{DSS}}$			50	μA
I_{GSS}	栅极漏电流 Gate leakage current	$V_{\text{GS}} = V_{\text{GSS}}, V_{\text{DS}} = 0\text{V}$			250	nA
$V_{\text{GS(th)}}^{(*)1}$	栅极-源极阈值电压 Gate threshold voltage	$I_{\text{D}} = 10\text{ mA}, V_{\text{GS}} = V_{\text{DS}}$	2.1	2.8	3.5	V
$R_{\text{DS(on)}}$	漏极-源极通态电阻 Drain-source on-state resistance	$V_{\text{GS}} = 18\text{V}, I_{\text{D}} = 52\text{A}$		25	38	m Ω
		$V_{\text{GS}} = 18\text{V}, I_{\text{D}} = 52\text{A}, T_{\text{vj}} = 175\text{ °C}$		45		m Ω
		$V_{\text{GS}} = 15\text{V}, I_{\text{D}} = 52\text{A}$		34		m Ω
		$V_{\text{GS}} = 15\text{V}, I_{\text{D}} = 52\text{A}, T_{\text{vj}} = 175\text{ °C}$		50		m Ω
g_{fs}	跨导 Forward transconductance	$V_{\text{DS}} = 20\text{V}, I_{\text{D}} = 52\text{A}$		23.8		S
C_{iss}	输入电容 Input capacitance	$V_{\text{DS}} = 1000\text{V}, V_{\text{GS}} = 0\text{V},$ $f = 100\text{kHz}, V_{\text{AC}} = 30\text{mV}$		2751		pF
C_{oss}	输出电容 Output capacitance			170		pF
C_{rss}	反向传输电容 Reverse transfer capacitance			12		pF
E_{oss}	电容存储能量 C_{oss} Stored Energy			84		μJ
R_{Gint}	内部栅极电阻 Internal gate resistor	$V_{\text{GS}} = 0\text{V}$		5		Ω
Q_{gs}	栅源电荷 Gate to source charge	$I_{\text{D}} = 52\text{A}, V_{\text{DS}} = 800\text{V}, V_{\text{GS}} = -4/+18\text{V}$		26.5		nC
Q_{gd}	栅漏电荷 Gate to drain charge			93		nC
Q_{g}	总栅极电荷 Total gate charge			118		nC
V_{SD}	二极管正向电压 Diode forward voltage	$I_{\text{SD}} = 52\text{A}, V_{\text{GS}} = -4\text{V}$		5.0		V
		$I_{\text{SD}} = 52\text{A}, V_{\text{GS}} = -4\text{V}, T_{\text{vj}} = 175\text{ °C}$		4.5		V

注意: 1.(*1)表示做过预处理后的测试值

Note: 1.(*1)Indicates $V_{\text{GS(th)}}$ is pre-processed).

电特性值
Electrical Characteristics

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions		最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit	
$t_{d(off)}$	关断延迟时间 Turn-off delay time	$I_D = 33A,$ $V_{DS} = 800V,$ $V_{GS} = -4/+15V,$ $R_{G(OFF)} = 0.0\Omega,$ $dv/dt = 67860V/\mu s$ ($T_{vj} = 175^\circ C$)	$T_{vj} = 25^\circ C$		26		ns	
			$T_{vj} = 175^\circ C$		28			
t_f	下降时间 Fall time		$T_{vj} = 25^\circ C$		15		ns	
			$T_{vj} = 175^\circ C$		18			
E_{OFF}	关断损耗 Turn-off energy loss		$T_{vj} = 25^\circ C$		108		uJ	
			$T_{vj} = 175^\circ C$		130			
$t_{d(on)}$	开通延迟时间 Turn-on delay time		$I_D = 33A,$ $V_{DS} = 800V,$ $V_{GS} = -4/+15V,$ $R_{G(ON)} = 3.9\Omega,$ $di/dt = 1500A/\mu s$ ($T_{vj} = 175^\circ C$)	$T_{vj} = 25^\circ C$		11		ns
				$T_{vj} = 175^\circ C$		13		
t_r	上升时间 Rise time	$T_{vj} = 25^\circ C$			12		ns	
		$T_{vj} = 175^\circ C$			12			
E_{ON}	开通损耗 Turn-on energy loss	$T_{vj} = 25^\circ C$			312		uJ	
		$T_{vj} = 175^\circ C$			334			
Q_{rr}	二极管反向恢复电荷 Diode reverse recovery charge	$I_D = 33A,$ $V_{DS} = 800V,$ $- di_{SD}/dt = 1500A/\mu s$ ($T_{vj} = 175^\circ C$)		$T_{vj} = 25^\circ C$		143		nC
				$T_{vj} = 175^\circ C$		220		
I_{rr}	二极管反向恢复电流 Diode reverse recovery current		$T_{vj} = 25^\circ C$		7		A	
			$T_{vj} = 175^\circ C$		10			

电特性值
Electrical Characteristics

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions		最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
$t_{d(off)}$	关断延迟时间 Turn-off delay time	$I_D = 33A,$ $V_{DS} = 800V,$ $V_{GS} = -4/+18V,$ $R_{G(OFF)} = 0.0\Omega,$ $dv/dt = 75400V/\mu s$ ($T_{vj} = 175\text{ }^{\circ}C$)	$T_{vj} = 25\text{ }^{\circ}C$		28		ns
			$T_{vj} = 175\text{ }^{\circ}C$		30		
t_f	下降时间 Fall time		$T_{vj} = 25\text{ }^{\circ}C$		15		ns
			$T_{vj} = 175\text{ }^{\circ}C$		17		
E_{OFF}	关断损耗 Turn-off energy loss		$T_{vj} = 25\text{ }^{\circ}C$		120		uJ
			$T_{vj} = 175\text{ }^{\circ}C$		144		
$t_{d(on)}$	开通延迟时间 Turn-on delay time	$I_D = 33A,$ $V_{DS} = 800V,$ $V_{GS} = -4/+18V,$ $R_{G(ON)} = 5.1\Omega,$ $di/dt = 1500A/\mu s$ ($T_{vj} = 175\text{ }^{\circ}C$)	$T_{vj} = 25\text{ }^{\circ}C$		12		ns
			$T_{vj} = 175\text{ }^{\circ}C$		13		
t_r	上升时间 Rise time		$T_{vj} = 25\text{ }^{\circ}C$		12		ns
			$T_{vj} = 175\text{ }^{\circ}C$		12		
E_{ON}	开通损耗 Turn-on energy loss		$T_{vj} = 25\text{ }^{\circ}C$		347		uJ
			$T_{vj} = 175\text{ }^{\circ}C$		371		
Q_{rr}	二极管反向恢复电荷 Diode reverse recovery charge	$I_D = 33A,$ $V_{DS} = 800V,$ - $dI_{SD}/dt = 1500A/\mu s$ ($T_{vj} = 175\text{ }^{\circ}C$)	$T_{vj} = 25\text{ }^{\circ}C$		143		nC
			$T_{vj} = 175\text{ }^{\circ}C$		220		
I_{rr}	二极管反向恢复电流 Diode reverse recovery current		$T_{vj} = 25\text{ }^{\circ}C$		7		A
			$T_{vj} = 175\text{ }^{\circ}C$		10		

热学特性
Thermal Characristics

符号 (Symbol)	参数名称 (Parameter)	条件 (Test Conditions)	最小值 (Min)	典型值 (Typ)	最大值 (Max)	单位 (Unit)
$R_{\theta VJ-C}$	结到壳热阻 Thermal resistance, junction – case	$T_C = 25^\circ C, T_{vj} = 175^\circ C$		0.34		K/W

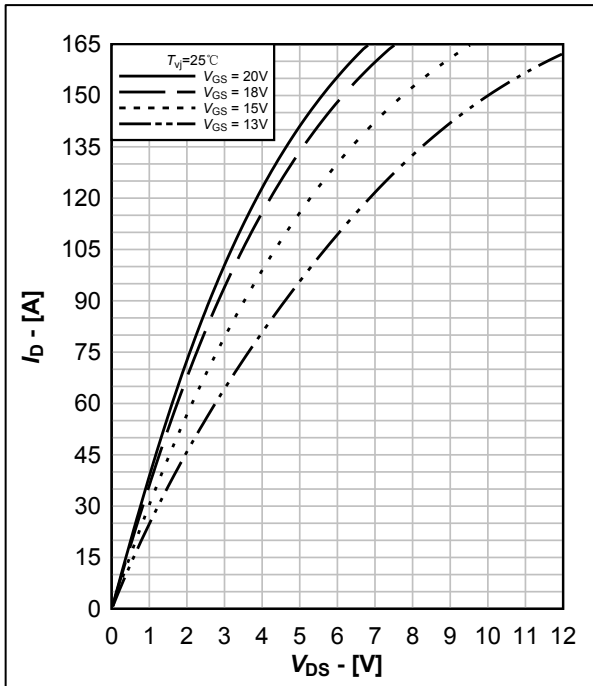


图 3. 输出特性典型曲线, $I_D = f(V_{DS})$, $T_{vj} = 25\text{ }^{\circ}\text{C}$

Fig.3 Typical output characteristics, $I_D = f(V_{DS})$, $T_{vj} = 25\text{ }^{\circ}\text{C}$

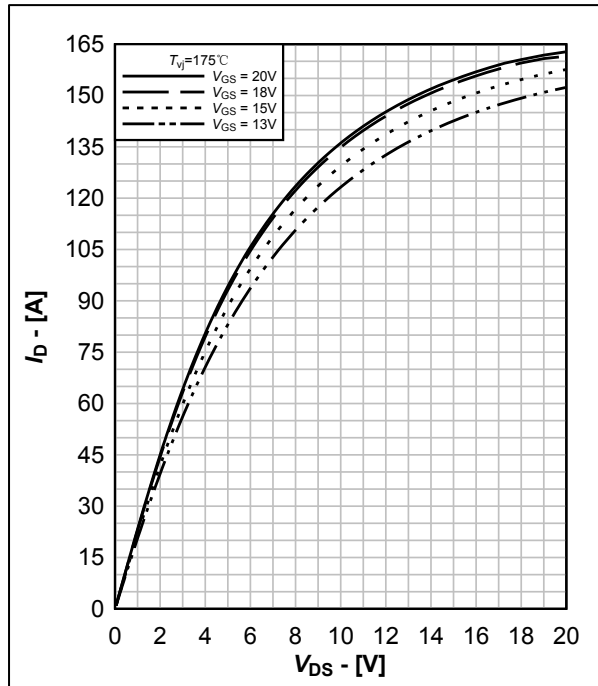


图 4. 输出特性典型曲线, $I_D = f(V_{DS})$, $T_{vj} = 175\text{ }^{\circ}\text{C}$

Fig.4 Typical output characteristics, $I_D = f(V_{DS})$, $T_{vj} = 175\text{ }^{\circ}\text{C}$

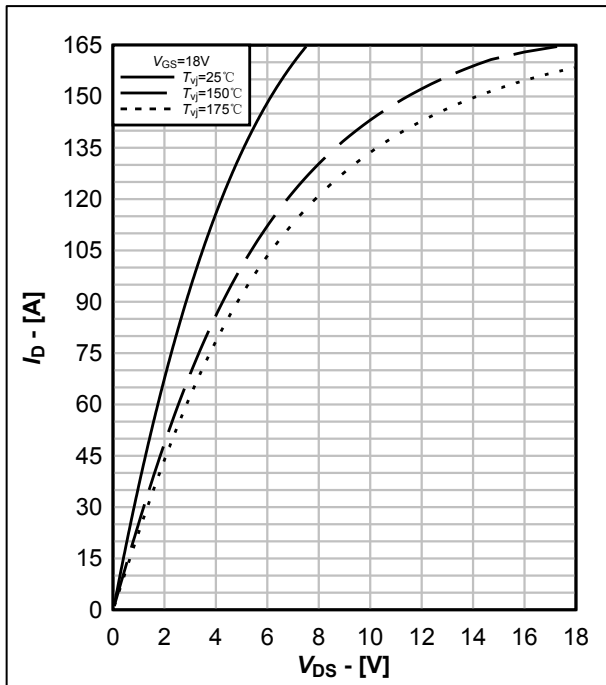


图 5. 输出特性典型曲线, $I_D = f(V_{DS})$

Fig.5 Typical output characteristics, $I_D = f(V_{DS})$

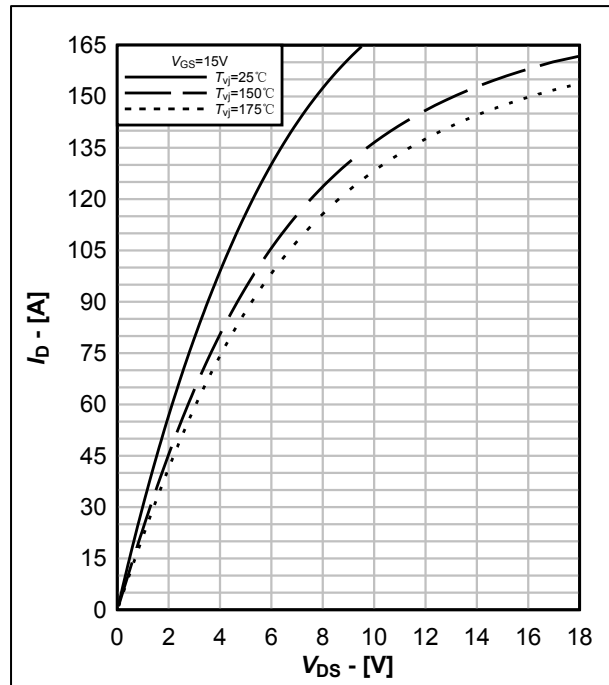


图 6. 输出特性典型曲线, $I_D = f(V_{DS})$

Fig.6 Typical output characteristics, $I_D = f(V_{DS})$

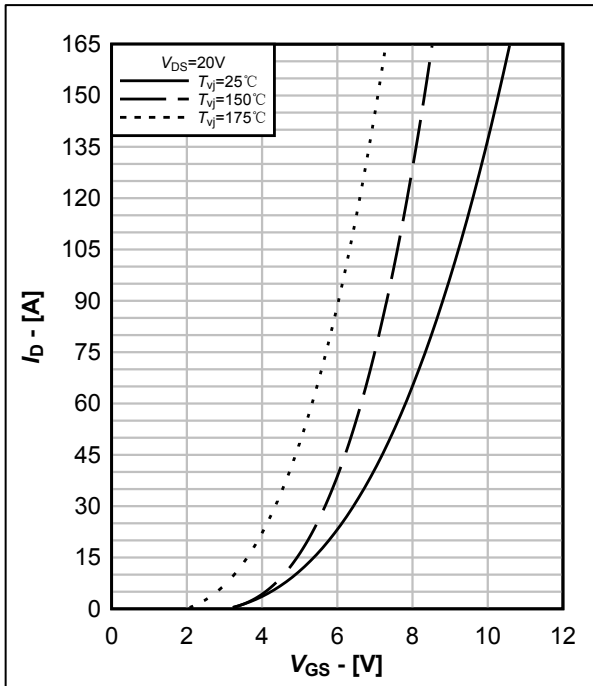


图 7. 传输特性典型曲线, $I_D = f(V_{GS})$

Fig.7 Typical transfer characteristics, $I_D = f(V_{GS})$

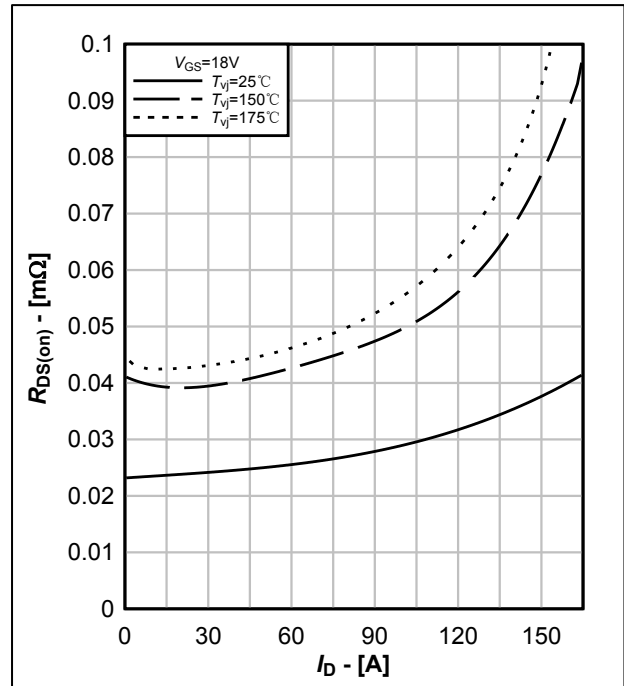


图 8. 导通电阻典型曲线, $R_{DS(on)} = f(I_D)$

Fig.8 Typical On-Resistance characteristics, $R_{DS(on)} = f(I_D)$

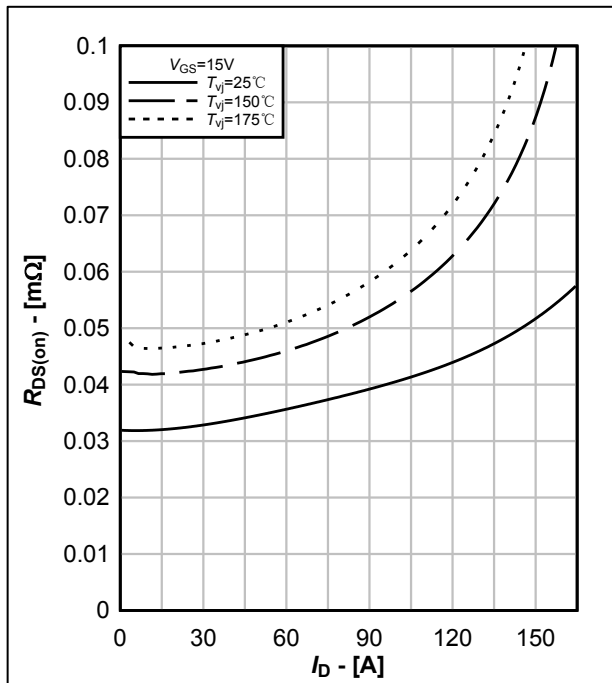


图 9. 导通电阻典型曲线, $R_{DS(on)} = f(I_D)$

Fig.9 Typical On-Resistance characteristics, $R_{DS(on)} = f(I_D)$

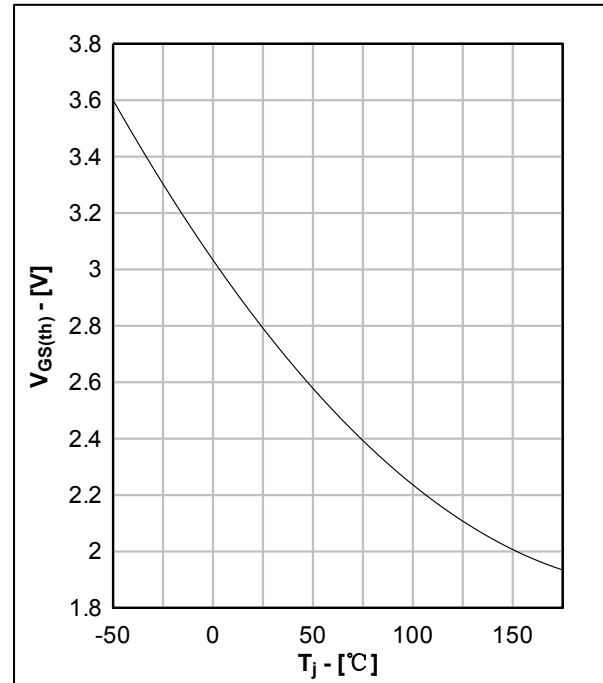


图 10. 阈值电压典型曲线, $V_{GS(th)} = f(T_j)$

Fig.10 Typical $V_{GS(th)}$ characteristics, $V_{GS(th)} = f(T_j)$

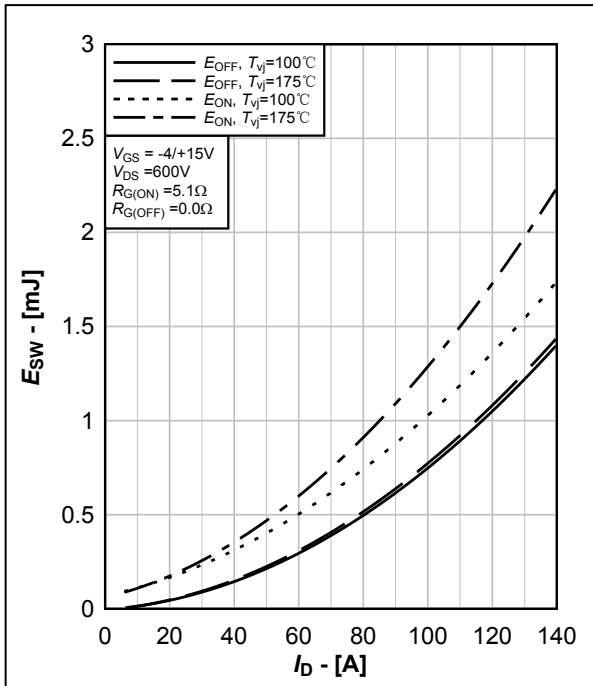

 图 11. MOSFET 开关损耗典型曲线, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

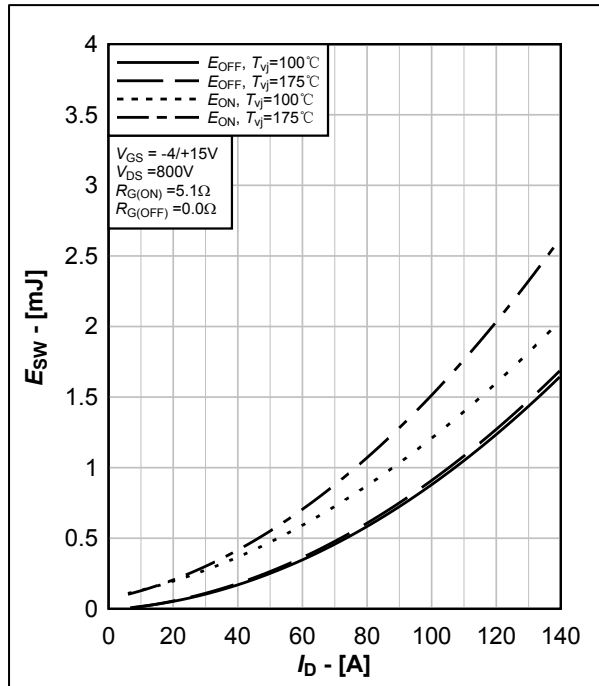
 Fig.12 Typical MOSFET switching energy, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

 图 12. MOSFET 开关损耗典型曲线, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

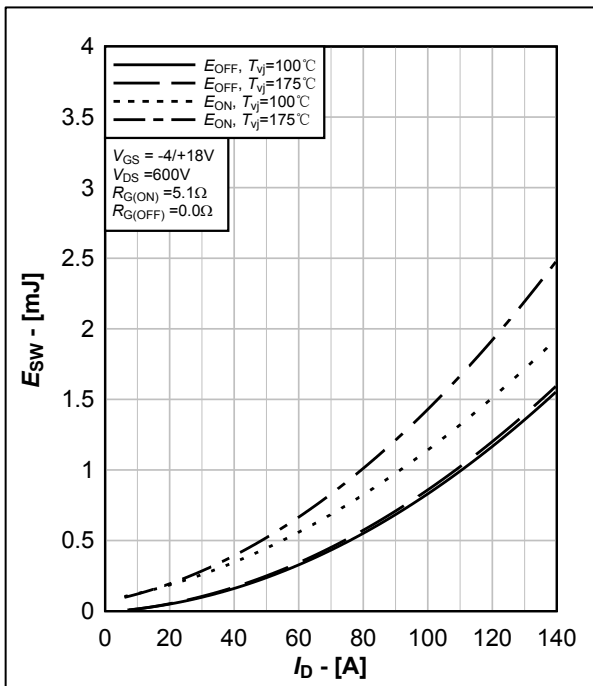
 Fig.12 Typical MOSFET switching energy, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

 图 13. MOSFET 开关损耗典型曲线, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

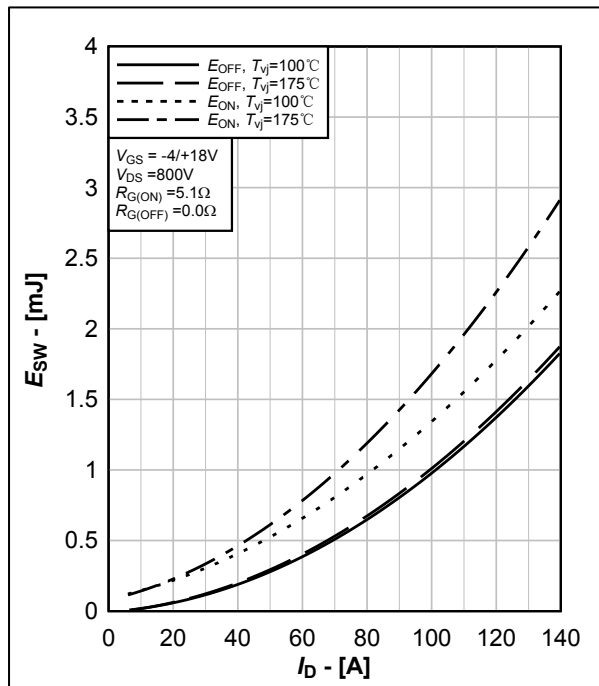
 Fig.13 Typical MOSFET switching energy, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

 图 14. MOSFET 开关损耗典型曲线, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

 Fig.14 Typical MOSFET switching energy, $E_{\text{off}} = f(I_D)$, $E_{\text{on}} = f(I_D)$

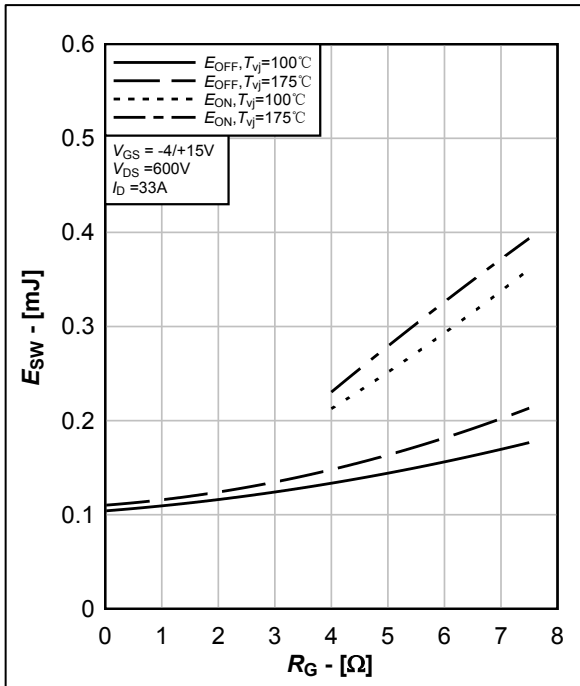

 图 15. MOSFET 开关损耗典型曲线, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

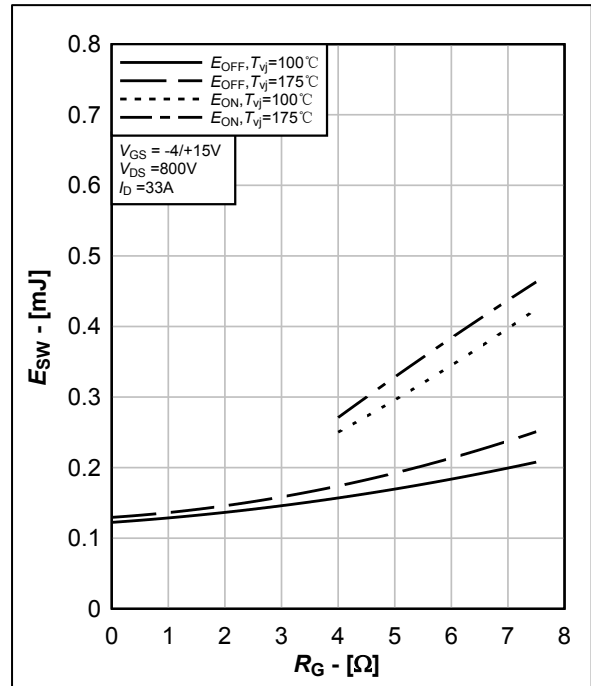
 Fig.15 Typical MOSFET switching energy, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

 图 16. MOSFET 开关损耗典型曲线, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

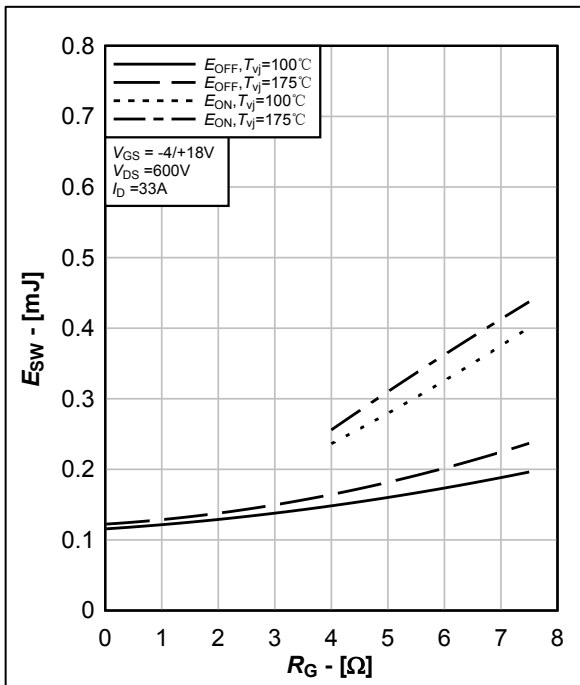
 Fig.16 Typical MOSFET switching energy, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

 图 17. MOSFET 开关损耗典型曲线, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

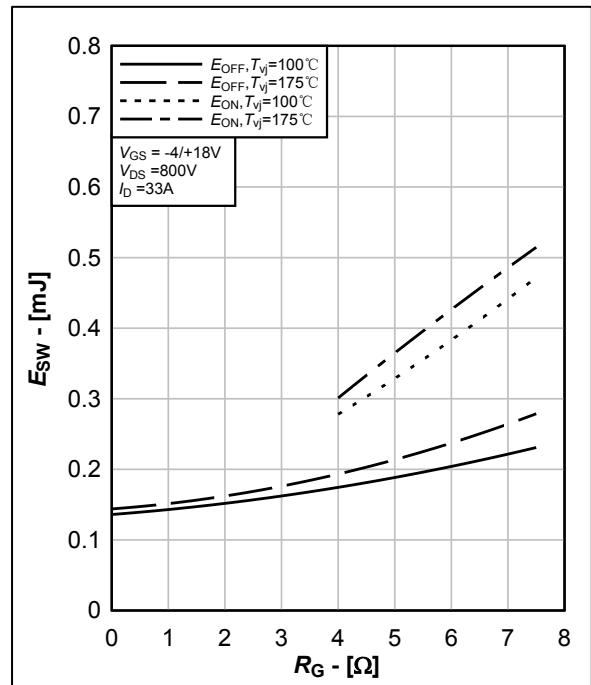
 Fig.17 Typical MOSFET switching energy, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

 图 18. MOSFET 开关损耗典型曲线, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

 Fig.18 Typical MOSFET switching energy, $E_{on}=f(R_G)$, $E_{off}=f(R_G)$

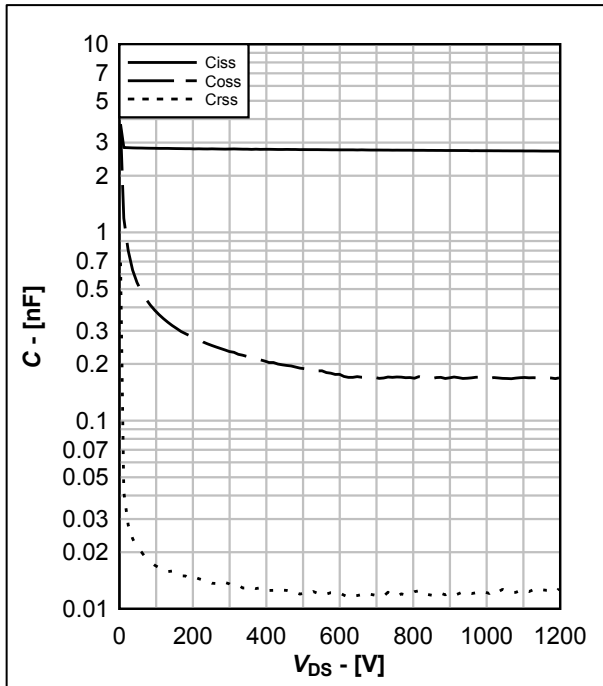


图 19. 电容特性典型曲线, $C = f(V_{DS})$

Fig.19 Typical capacity characteristic, $C = f(V_{DS})$

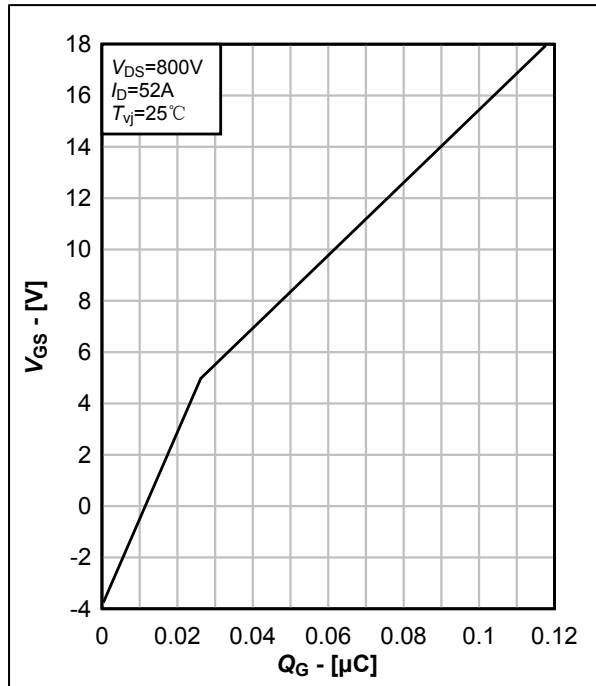


图 20. 栅极电荷特性典型曲线, $V_{GS} = f(Q_G)$

Fig.20 Typical gate charge characteristic, $V_{GS} = f(Q_G)$

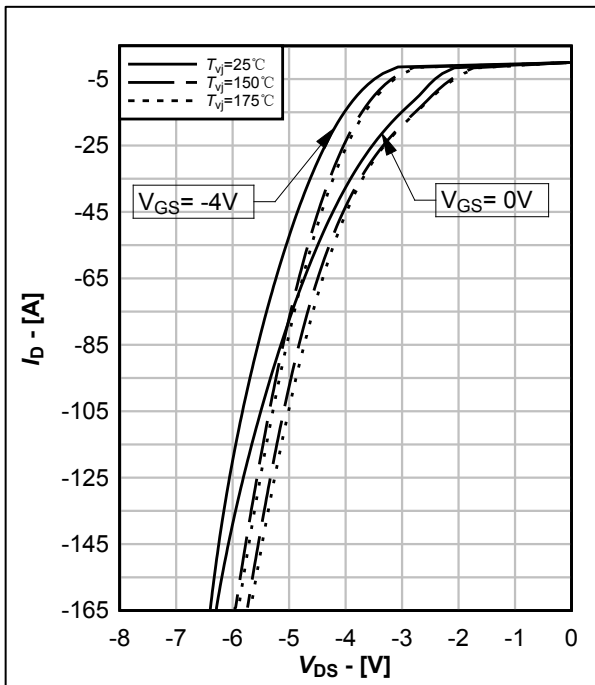


图 21. 体二极管及第三象限输出特性典型曲线, $I_D = f(V_{DS})$

Fig.21 Typical body diode output and 3rd quadrant characteristic,

$$I_D = f(V_{DS})$$

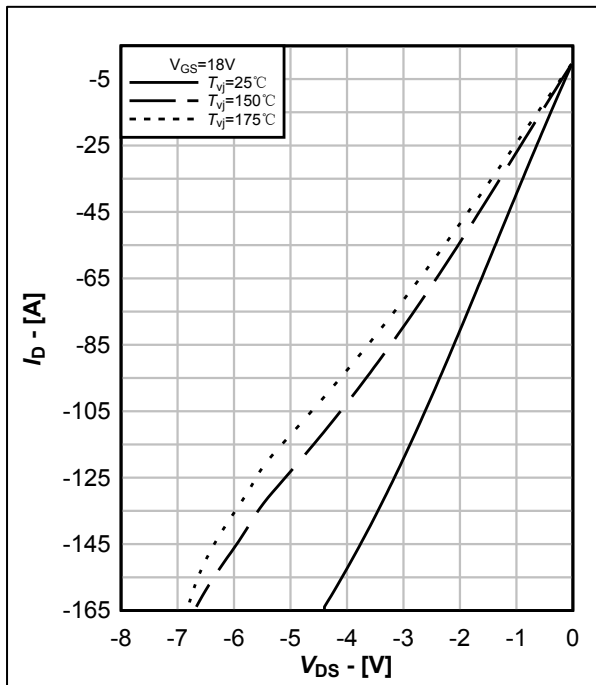


图 22. 体二极管及第三象限输出特性典型曲线, $I_D = f(V_{DS})$

Fig.22 Typical body diode output and 3rd quadrant characteristic,

$$I_D = f(V_{DS})$$

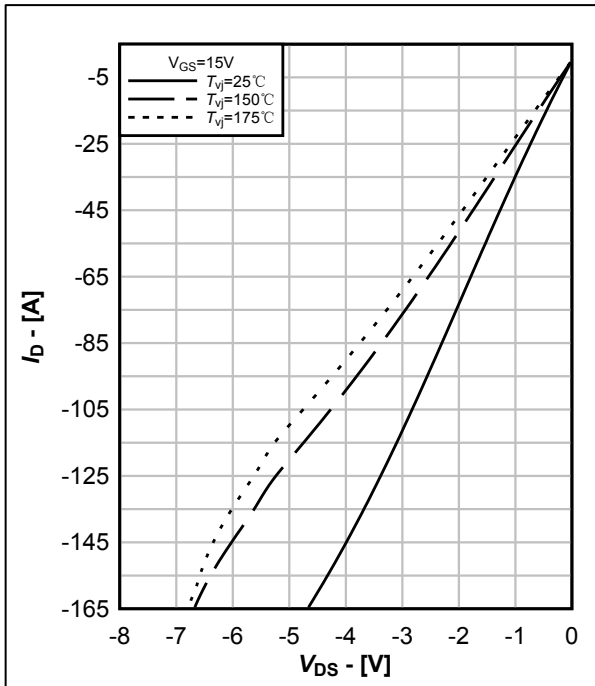


图 23. 导通电阻典型曲线, $R_{DS(on)} = f(T_j)$

Fig.23 Typical On-Resistance characteristics, $R_{DS(on)} = f(T_j)$

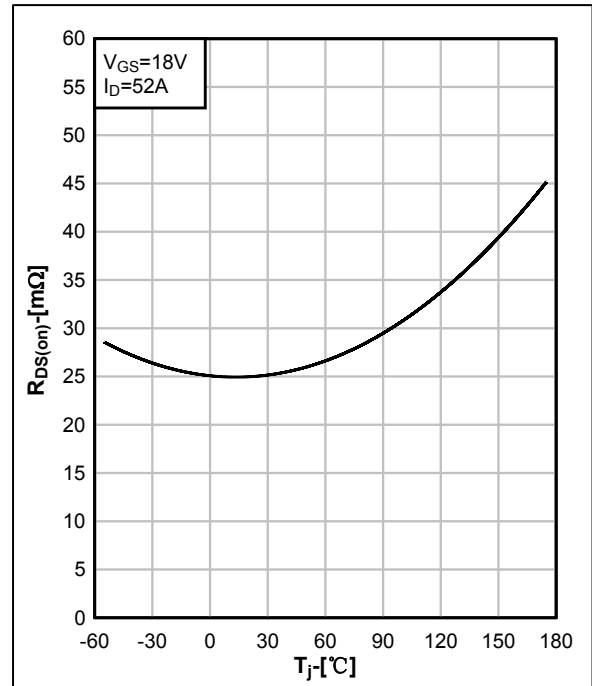


图 24. 导通电阻典型曲线, $R_{DS(on)} = f(T_j)$

Fig.24 Typical On-Resistance characteristics, $R_{DS(on)} = f(T_j)$

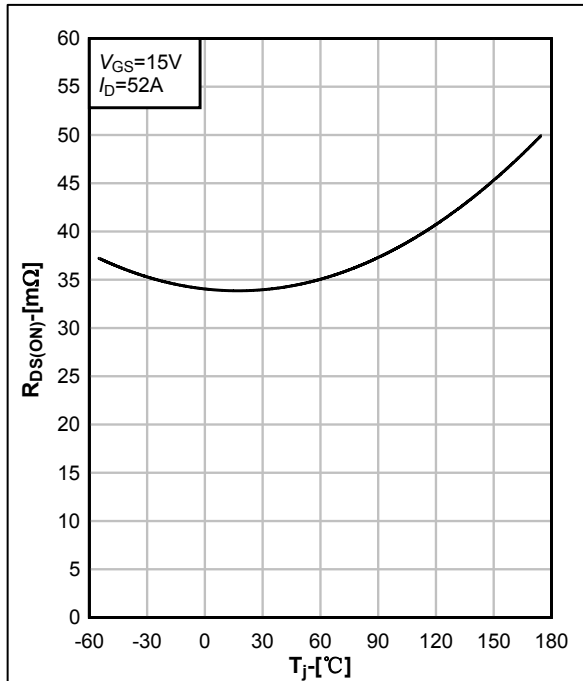


图 25. 导通电阻典型曲线, $R_{DS(on)} = f(T_j)$

Fig.25 Typical On-Resistance characteristics, $R_{DS(on)} = f(T_j)$

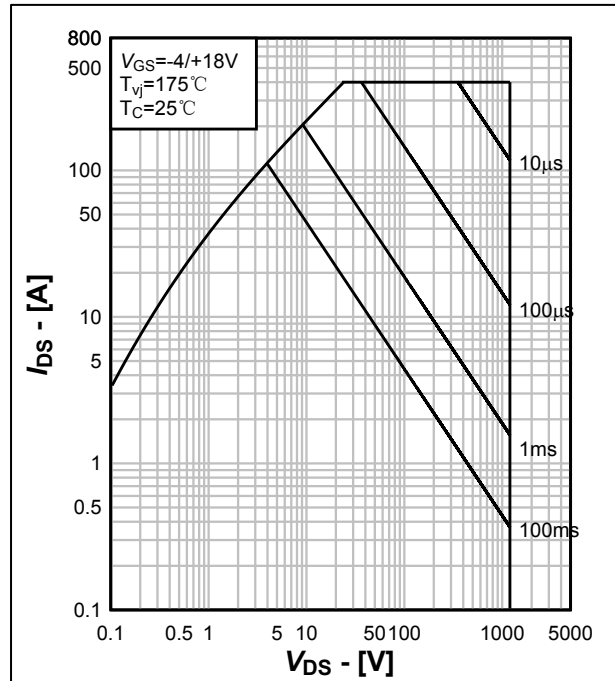


图 26. MOSFET 安全工作区, $I_D = f(V_{DS})$

Fig.26 MOSFET Safe Opreating Area, $I_D = f(V_{DS})$

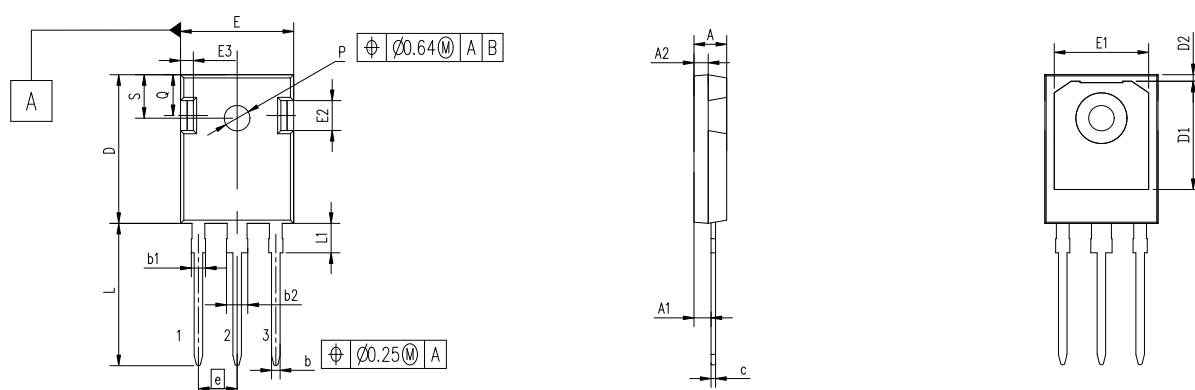


图 27. 封装尺寸

Fig. 27 Package Dimensions

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(5) 产品数据手册首页的右上角，会显示产品的状态。如果它尚未完全批准，会标示**初版 (preliminary)**，该标示意味着该产品已完成设计，量产的产品参数正在确定中，数据手册中的产品信息目前是可以参考的，但将来某些细节可能会发生变化。如果产品数据手册首页的右上角没有标注，则表示该产品已可以批量生产。

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